MULTI-COM.PL



Low-melting point tin Bi57Sn42Ag1 - 0.50mm / 25g solder

Product ID: 23379

Price: **17.00 EUR**

Product weight: **0.25 kg**

Description:

Low-melting point tin Bi57Sn42Ag1 - 0.50mm / 25g solder (57% bismuth, 42% tin, 1% silver) is manufactured from primary raw materials in their first melt. It has a low melting temperature, making it suitable for soldering devices and components that are sensitive to damage from higher temperatures when using conventional solders. It features excellent wettability and fast flow. The alloy complies with the ROHS directive (2002/95/EC).

Go to the product

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